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3.75 Gbps Quad Bidirectional CX4 Equalizer

ADN8102

FEATURES

- Optimized for dc to 3.75 Gbps data
- Programmable input equalization
  - Up to 22 dB boost at 1.875 GHz
  - Compensates up to 30 meters of CX4 cable up to 3.75 Gbps
  - Compensates up to 40 inches of FR4 up to 3.75 Gbps
- Programmable output pre-emphasis/de-emphasis
  - Up to 12 dB boost at 1.875 GHz (3.75 Gbps)
  - Compensates up to 15 meters of CX4 cable up to 3.75 Gbps
  - Compensates up to 40 inches of FR4 up to 3.75 Gbps
- Flexible 1.8 V to 3.3 V core supply
- Per lane P/N pair inversion for routing ease
- Low power: 125 mW/channel up to 3.75 Gbps
- DC- or ac-coupled differential CML inputs
- Programmable CML output levels
- 50 Ω on-chip termination
- Loss-of-signal detection
- Temperature range operation: −40°C to +85°C
- Supports 8b10b, scrambled, or uncoded NRZ data
- I²C control interface
- 64-lead LFCSP (QFN) package

APPLICATIONS

- 10GBase-CX4
- HiGig™
- InfiniBand®
- 1×, 2× Fibre Channel
- XAUI™
- Gigabit Ethernet over backplane or cable
- CPRI™
- 50 Ω cables

FUNCTIONAL BLOCK DIAGRAM

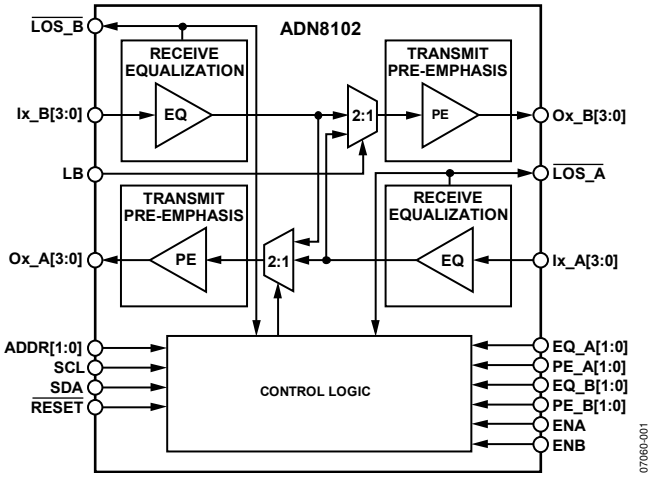

Figure 1.

GENERAL DESCRIPTION

The ADN8102 is a quad, bidirectional, CX4 cable/backplane equalizer with eight differential PECL-/CML-compatible inputs with programmable equalization and eight differential CML outputs with programmable output levels and pre-emphasis or de-emphasis. The operation of this device is optimized for NRZ data at rates up to 3.75 Gbps.

The receive inputs provide programmable equalization to compensate for up to 30 meters of CX4 cable (24 AWG) or 40 inches of FR4, and programmable pre-emphasis to compensate for up to 15 meters of CX4 cable (24 AWG) or 40 inches of FR4 at 3.75 Gbps. Each channel also provides programmable loss-of-signal detection and loopback capability for system testing and debugging.

The ADN8102 is controlled through toggle pins, an I²C® control interface that provides more flexible control, or a combination of both. Every channel implements an asynchronous path supporting dc to 3.75 Gbps NRZ data, fully independent of other channels. The ADN8102 has low latency and very low channel-to-channel skew.

The main application for the ADN8102 is to support switching in chassis-to-chassis applications over CX4 or InfiniBand cables.

The ADN8102 is packaged in a 9 mm × 9 mm 64-lead LFCSP (QFN) package and operates from −40°C to +85°C.

Rev. B

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Last Content Update: 02/23/2017

COMPARABLE PARTS

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EVALUATION KITS

- ADN8102 Evaluation Board

DOCUMENTATION

Data Sheet

- ADN8102: X-stream™ 3.75 Gbps Quad Bidirectional CX4 Equalizer

DESIGN RESOURCES

- ADN8102 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all ADN8102 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK

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5/08—Revision 0: Initial Version

SPECIFICATIONS

V_{CC} = 1.8 V, V_{EE} = 0 V, V_{TTI} = V_{TTO} = V_{CC}, R_L = 50 Ω, differential output swing = 800 mV p-p differential, 3.75 Gbps, PRBS $2^7 - 1$, T_A = 25°C, unless otherwise noted.

Table 1.

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
DYNAMIC PERFORMANCE					
Maximum Data Rate/Channel (NRZ)		3.75			Gbps
Deterministic Jitter	Data rate < 3.75 Gbps; BER = 1×10^{-12}		33		ps p-p
Random Jitter	V_{CC} = 1.8 V		1.5		ps rms
Residual Deterministic Jitter					
With Input Equalization	Data rate < 3.25 Gbps; 0 inches to 40 inches FR4		0.20		UI
	Data rate < 3.25 Gbps; 0 meters to 30 meters CX4		0.19		UI
	Data rate < 3.75 Gbps; 0 inches to 40 inches FR4		0.24		UI
	Data rate < 3.75 Gbps; 0 meters to 30 meters CX4		0.21		UI
With Output Pre-Emphasis	Data rate < 3.25 Gbps; 0 inches to 40 inches FR4		0.13		UI
	Data rate < 3.25 Gbps; 0 meters to 15 meters CX4		0.37		UI
	Data rate < 3.75 Gbps; 0 inches to 40 inches FR4		0.14		UI
	Data rate < 3.75 Gbps; 0 meters to 15 meters CX4		0.41		UI
Output Rise/Fall Time	20% to 80%		75		ps
Propagation Delay			1		ns
Channel-to-Channel Skew			50		ps
OUTPUT PRE-EMPHASIS					
Equalization Method	1-tap programmable pre-emphasis				
Maximum Boost	800 mV p-p output swing		6		dB
	200 mV p-p output swing		12		dB
Pre-Emphasis Tap Range	Minimum		2		mA
	Maximum		12		mA
INPUT EQUALIZATION					
Minimum Boost	EQBY = 1		1.5		dB
Maximum Boost	Maximum boost occurs at 1.875 GHz		22		dB
Number of Equalization Settings			8		
Gain Step Size			2.5		dB
INPUT CHARACTERISTICS					
Input Voltage Swing	Differential, V_{ICM}[1] = V_{CC} − 0.6 V	300		2000	mV p-p
Input Voltage Range	Single-ended absolute voltage level, V_L minimum		V_{EE} + 0.4		V p-p
	Single-ended absolute voltage level, V_H maximum		V_{CC} + 0.5		V p-p
Input Resistance	Single-ended	45	50	55	Ω
Input Return Loss	Measured at 2.5 GHz		5		dB
OUTPUT CHARACTERISTICS					
Output Voltage Swing	DC, differential, PE = 0, default, V_{CC} = 1.8 V	635	740	870	mV p-p
	DC, differential, PE = 0, default, V_{CC} = 3.3 V		800		mV p-p
	DC, differential, PE = 0, minimum output level,[2] V_{CC} = 1.8 V		100		mV p-p
	DC, differential, PE = 0, minimum output level,[2] V_{CC} = 3.3 V		100		mV p-p
	DC, differential, PE = 0, maximum output level,[2] V_{CC} = 1.8 V		1300		mV p-p
	DC, differential, PE = 0, maximum output level,[2] V_{CC} = 3.3 V		1800		mV p-p

Parameter	Test Conditions/Comments	Min	Typ	Max	Unit
Output Voltage Range	Single-ended absolute voltage level, TxHeadroom = 0; V_L minimum		V_{CC} − 1.1		V
	Single-ended absolute voltage level, TxHeadroom = 0; V_H maximum		V_{CC} + 0.6		V
	Single-ended absolute voltage level, TxHeadroom = 1; V_L minimum		V_{CC} − 1.2		V
	Single-ended absolute voltage level, TxHeadroom = 1; V_H maximum		V_{CC} + 0.6		V
Output Current	Minimum output current per channel		2		mA
	Maximum output current per channel, V_{CC} = 1.8 V		21		mA
Output Resistance	Single-ended	43	50	57	Ω
Output Return Loss	Measured at 2.5 GHz		5		dB
LOS CHARACTERISTICS					
Assert Level	IN_A/IN_B LOS threshold = 0x0C		20		mV diff
Deassert Level	IN_A/IN_B LOS hysteresis = 0x0D		225		mV diff
POWER SUPPLY					
Operating Range					
V_{CC}	V_{EE} = 0 V	1.7	1.8	3.6	V
DV_{CC}	V_{EE} = 0 V, $DV_{CC} \le (V_{CC} + 1.3\ V)$	3.0	3.3	3.6	V
V_{TTI}	$(V_{EE} + 0.4\ V + 0.5 \times V_{ID}) < V_{TTI} < (V_{CC} + 0.5\ V)$	V_{EE} + 0.4	1.8	3.6	V
V_{TTO}	$(V_{CC} - 1.1\ V + 0.5 \times V_{OD}) < V_{TTO} < (V_{CC} + 0.5\ V)$	V_{CC} − 1.1	1.8	3.6	V
Supply Current					
I_{TTO}	V_{TTO} = 1.8 V, all outputs enabled		63	69	mA
I_{CC}	V_{CC} = 1.8 V, all outputs enabled		460	565	mA
LOGIC CHARACTERISTICS					
Input High, V_{IH}	DV_{CC} = 3.3 V	2.5			V
Input Low, V_{IL}				1.0	V
Output High, V_{OH}		2.5			V
Output Low, V_{OL}				1.0	V
THERMAL CHARACTERISTICS					
Operating Temperature Range		−40		+85	°C
θ_{JA}			22		°C/W

[1] V_{ICM} is the input common-mode voltage.
[2] Programmable via I^2C.

TIMING SPECIFICATIONS

Table 2. I²C Timing Parameters

Parameter	Min	Max	Unit	Description
f_{SCL}	0	400	kHz	SCL clock frequency
$t_{HD:STA}$	0.6	Not applicable	µs	Hold time for a start condition
$t_{SU:STA}$	0.6	Not applicable	µs	Setup time for a repeated start condition
t_{LOW}	1.3	Not applicable	µs	Low period of the SCL clock
t_{HIGH}	0.6	Not applicable	µs	High period of the SCL clock
$t_{HD:DAT}$	0	Not applicable	µs	Data hold time
$t_{SU:DAT}$	10	Not applicable	ns	Data setup time
t_R	1	300	ns	Rise time for both SDA and SCL
t_F	1	300	ns	Fall time for both SDA and SCL
$t_{SU:STO}$	0.6	Not applicable	µs	Setup time for a stop condition
t_{BUF}	1	Not applicable	ns	Bus free time between a stop and a start condition
C_{IO}	5	7	pF	Capacitance for each I/O pin
t_{RESET}	10	Not applicable	ns	Reset pulse width[1]

[1] Reset pulse width is defined as the time $\overline{RESET}$ is held below the logic low threshold (V_{IL}) listed in Table 1 while the DV_{CC} supply is within the operating range in Table 1.

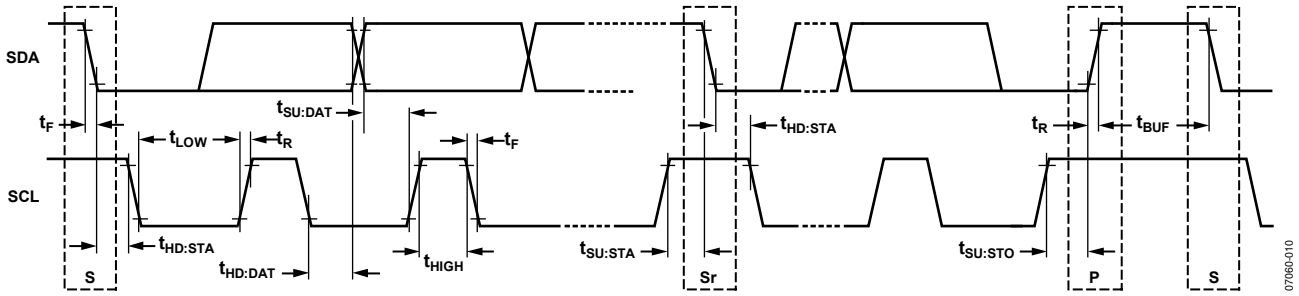

Figure 2. I²C Timing Diagram

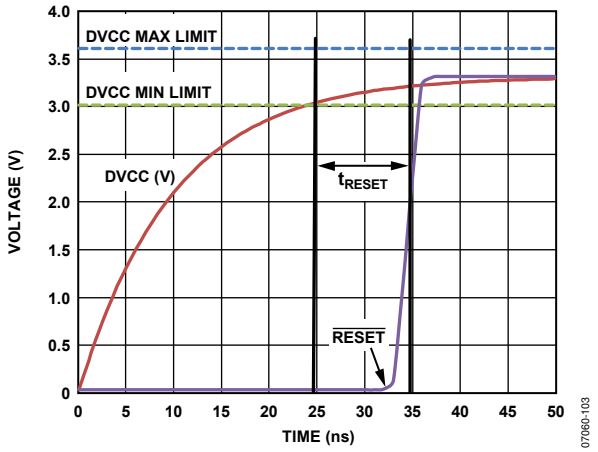

Figure 3. Reset Timing Diagram

ABSOLUTE MAXIMUM RATINGS

Table 3.

Parameter	Rating
V_{CC} to V_{EE}	3.7 V
V_{TTI}	V_{CC} + 0.6 V
V_{TTO}	V_{CC} + 0.6 V
Internal Power Dissipation	4.26 W
Differential Input Voltage	2.0 V
Logic Input Voltage	V_{EE} − 0.3 V < V_{IN} < V_{CC} + 0.6 V
Storage Temperature Range	−65°C to +125°C
Lead Temperature	300°C
Junction Temperature	125°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

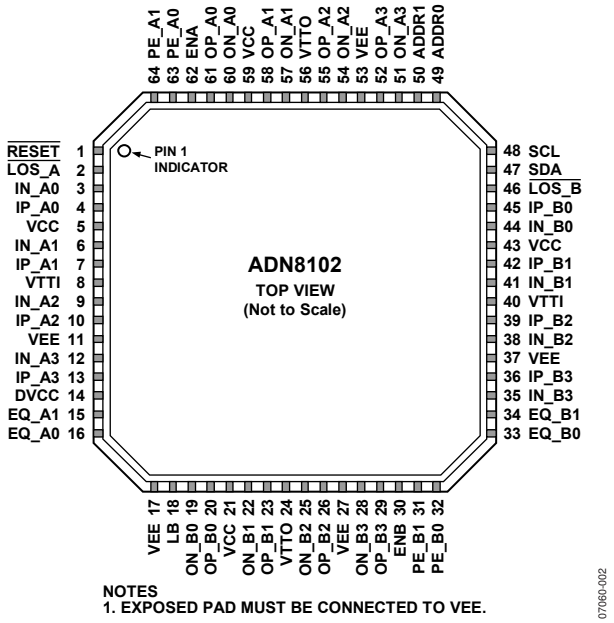

Figure 4. Pin Configuration

Table 4. Pin Function Descriptions

Pin No.	Mnemonic	Type	Description
1	$\overline{\text{RESET}}$	Control	Reset Input, Active Low
2	$\overline{\text{LOS\_A}}$	Digital I/O	Port A Loss of Signal Status, Active Low
3	IN_A0	I/O	High Speed Input Complement
4	IP_A0	I/O	High Speed Input
5	VCC	Power	Positive Supply
6	IN_A1	I/O	High Speed Input Complement
7	IP_A1	I/O	High Speed Input
8	VTTI	Power	Input Termination Supply
9	IN_A2	I/O	High Speed Input Complement
10	IP_A2	I/O	High Speed Input
11	VEE	Power	Negative Supply
12	IN_A3	I/O	High Speed Input Complement
13	IP_A3	I/O	High Speed Input
14	DVCC	Power	Digital Power Supply
15	EQ_A1	Control	Port A Input Equalization MSB
16	EQ_A0	Control	Port A Input Equalization LSB
17	VEE	Power	Negative Supply
18	LB	Control	Loopback Control
19	ON_B0	I/O	High Speed Output Complement
20	OP_B0	I/O	High Speed Output
21	VCC	Power	Positive Supply
22	ON_B1	I/O	High Speed Output Complement
23	OP_B1	I/O	High Speed Output
24	VTTO	Power	Output Termination Supply
25	ON_B2	I/O	High Speed Output Complement
26	OP_B2	I/O	High Speed Output
27	VEE	Power	Negative Supply

Pin No.	Mnemonic	Type	Description
28	ON_B3	I/O	High Speed Output Complement
29	OP_B3	I/O	High Speed Output
30	ENB	Control	Port B Enable
31	PE_B1	Control	Port B Output Pre-Emphasis MSB
32	PE_B0	Control	Port B Output Pre-Emphasis LSB
33	EQ_B0	Control	Port B Input Equalization LSB
34	EQ_B1	Control	Port B Input Equalization MSB
35	IN_B3	I/O	High Speed Input Complement
36	IP_B3	I/O	High Speed Input
37	VEE	Power	Negative Supply
38	IN_B2	I/O	High Speed Input Complement
39	IP_B2	I/O	High Speed Input
40	VTTI	Power	Input Termination Supply
41	IN_B1	I/O	High Speed Input Complement
42	IP_B1	I/O	High Speed Input
43	VCC	Power	Positive Supply
44	IN_B0	I/O	High Speed Input Complement
45	IP_B0	I/O	High Speed Input
46	$\overline{\text{LOS\_B}}$	Digital I/O	Port B Loss of Signal Status, Active Low
47	SDA	Control	I^2C Control Interface Data Input/Output
48	SCL	Control	I^2C Control Interface Clock Input
49	ADDR0	Control	I^2C Control Interface Address LSB
50	ADDR1	Control	I^2C Control Interface Address MSB
51	ON_A3	I/O	High Speed Output Complement
52	OP_A3	I/O	High Speed Output
53	VEE	Power	Negative Supply
54	ON_A2	I/O	High Speed Output Complement
55	OP_A2	I/O	High Speed Output
56	VTTO	Power	Output Termination Supply
57	ON_A1	I/O	High Speed Output Complement
58	OP_A1	I/O	High Speed Output
59	VCC	Power	Positive Supply
60	ON_A0	I/O	High Speed Output Complement
61	OP_A0	I/O	High Speed Output
62	ENA	Control	Port A Enable
63	PE_A0	Control	Port A Output Pre-Emphasis LSB
64	PE_A1	Control	Port A Output Pre-Emphasis MSB
EP	EPAD	Power	EPAD Must Be Connected to VEE

TYPICAL PERFORMANCE CHARACTERISTICS

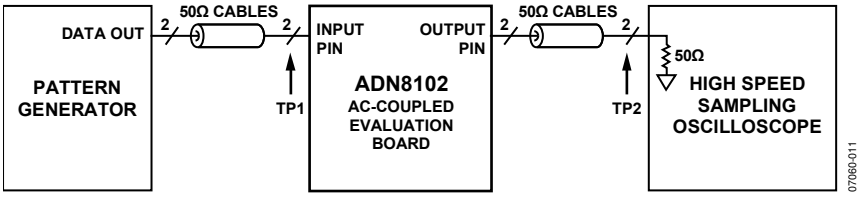

Figure 5. Standard Test Circuit (No Channel)

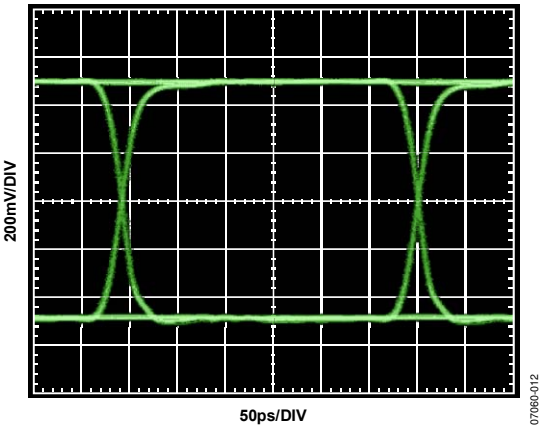

Figure 6. 3.25 Gbps Input Eye (TP1 from Figure 5)

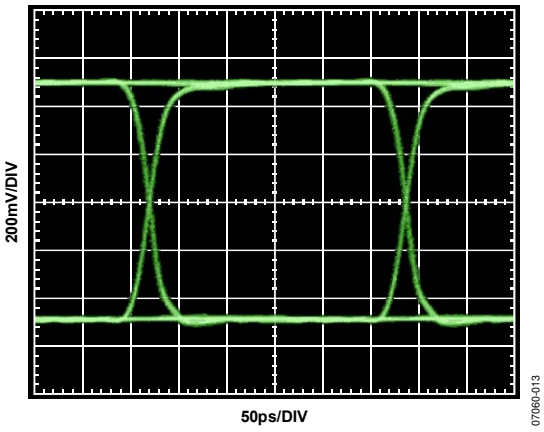

Figure 7. 3.75 Gbps Input Eye (TP1 from Figure 5)

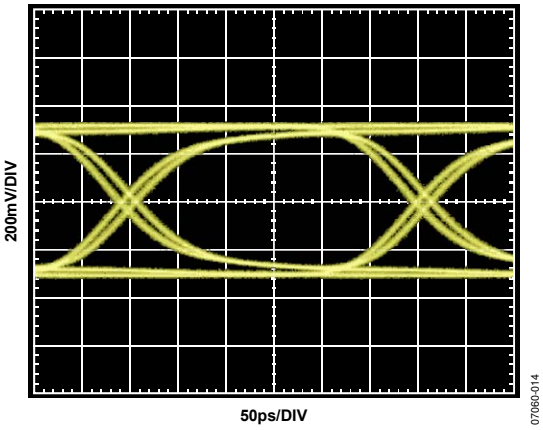

Figure 8. 3.25 Gbps Output Eye, No Channel (TP2 from Figure 5)

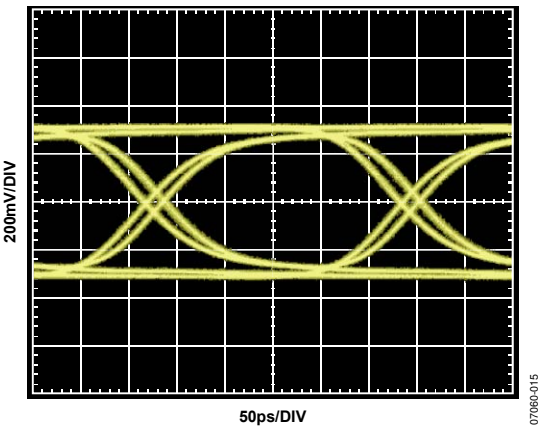

Figure 9. 3.75 Gbps Output Eye, No Channel (TP2 from Figure 5)

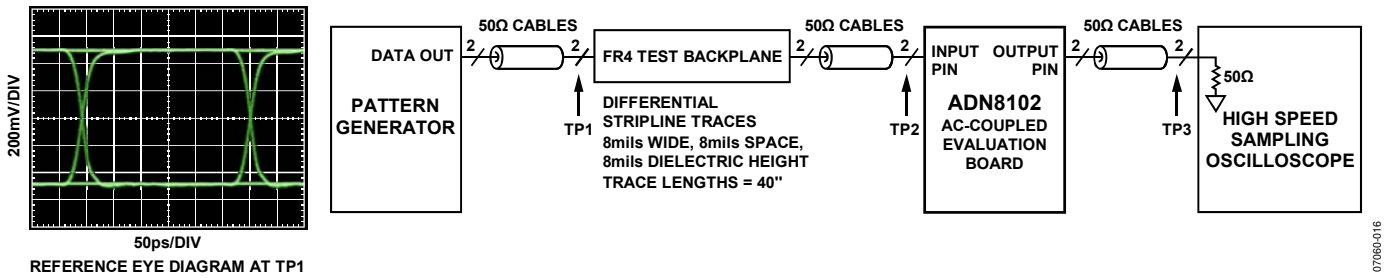

Figure 10. Input Equalization Test Circuit, FR4

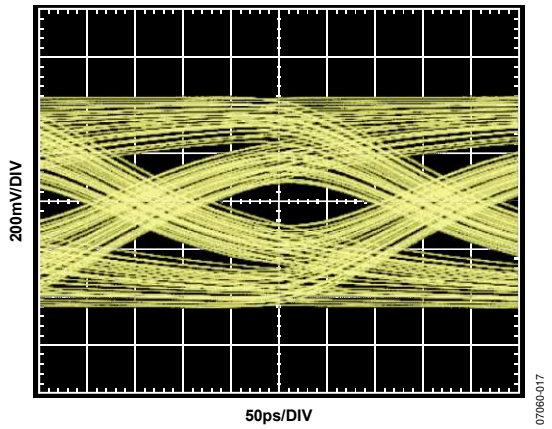

Figure 11. 3.25 Gbps Input Eye, 40 Inch FR4 Input Channel (TP2 from Figure 10)

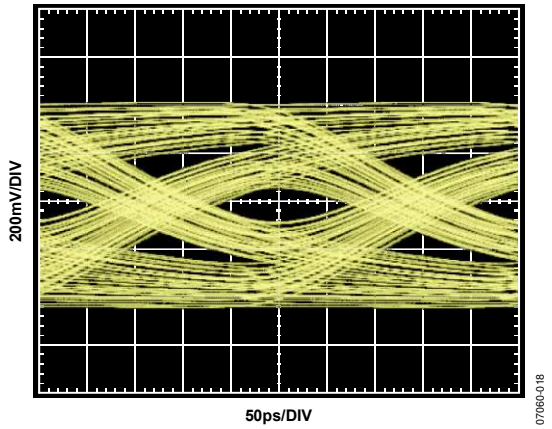

Figure 12. 3.75 Gbps Input Eye, 40 Inch FR4 Input Channel (TP2 from Figure 10)

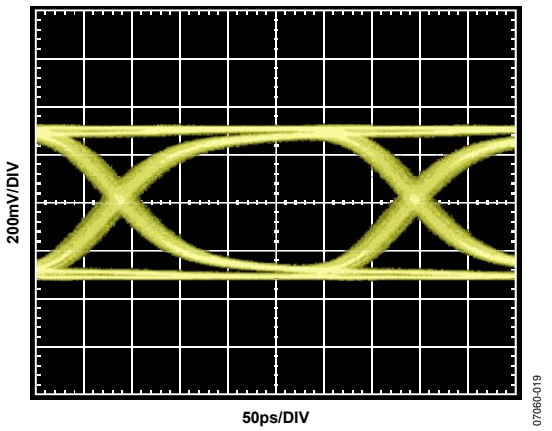

Figure 13. 3.25 Gbps Output Eye, 40 Inch FR4 Input Channel, Best EQ Setting (TP3 from Figure 10)

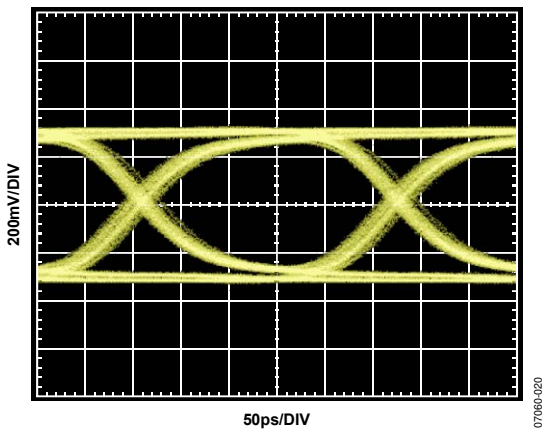

Figure 14. 3.75 Gbps Output Eye, 40 Inch FR4 Input Channel, Best EQ Setting (TP3 from Figure 10)

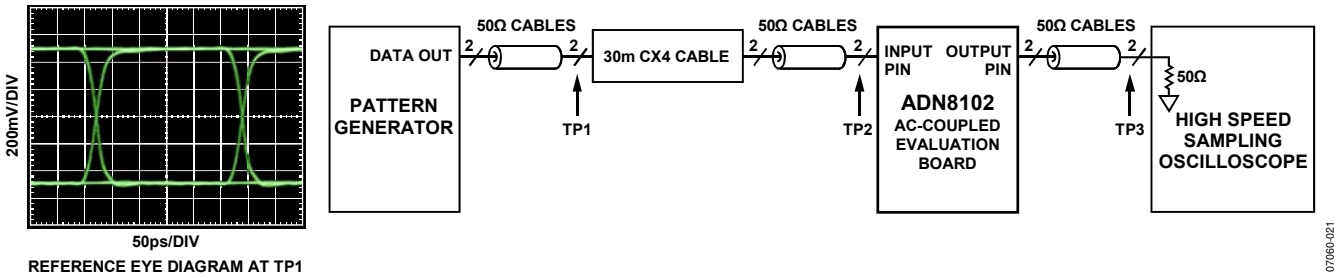

Figure 15. Input Equalization Test Circuit, CX4

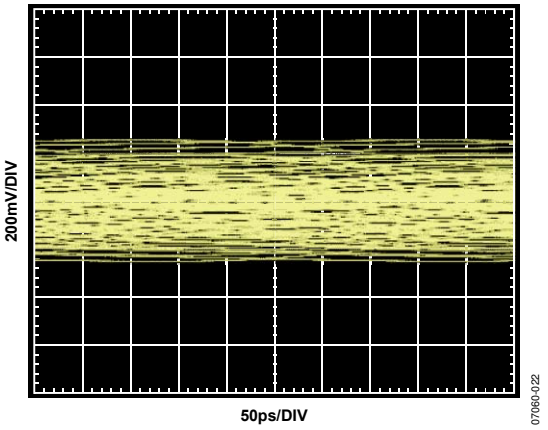

Figure 16. 3.25 Gbps Input Eye, 30 Meters CX4 Cable (TP2 from Figure 15)

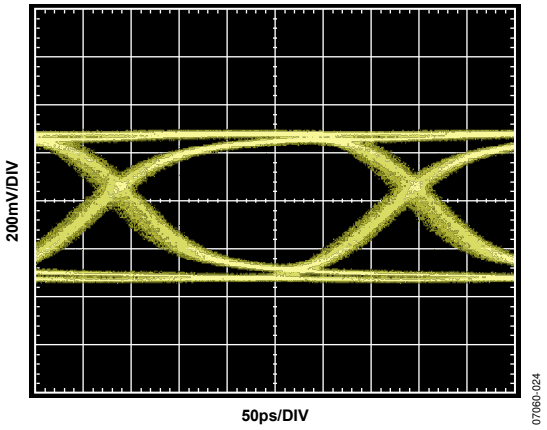

Figure 18. 3.25 Gbps Output Eye, 30 Meters CX4 Cable, Best EQ Setting (TP3 from Figure 15)

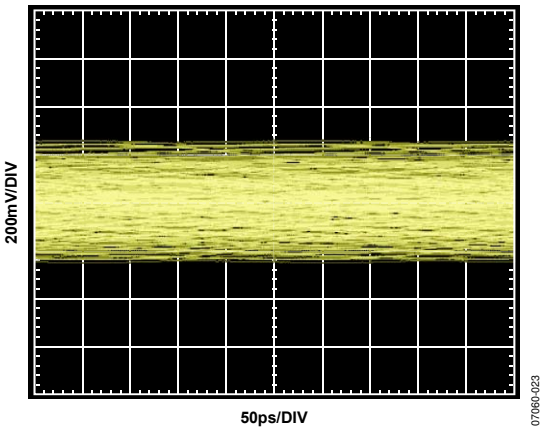

Figure 17. 3.75 Gbps Input Eye, 30 Meters CX4 Cable (TP2 from Figure 15)

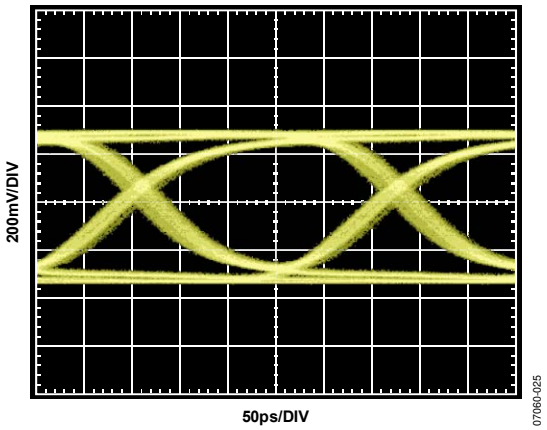

Figure 19. 3.75 Gbps Output Eye, 30 Meters CX4 Cable, Best EQ Setting (TP3 from Figure 15)

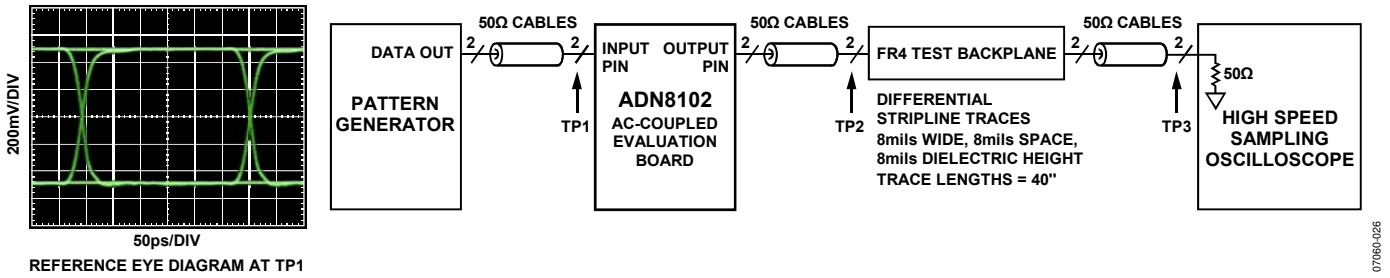

Figure 20. Output Pre-Emphasis Test Circuit, FR4

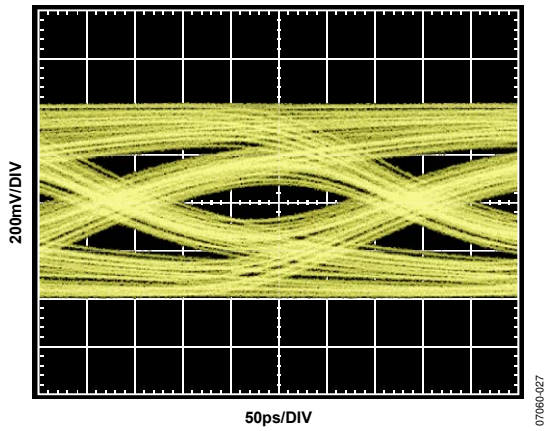

Figure 21. 3.25 Gbps Output Eye, 40 Inch FR4 Output Channel, PE = 0 (TP3 from Figure 20)

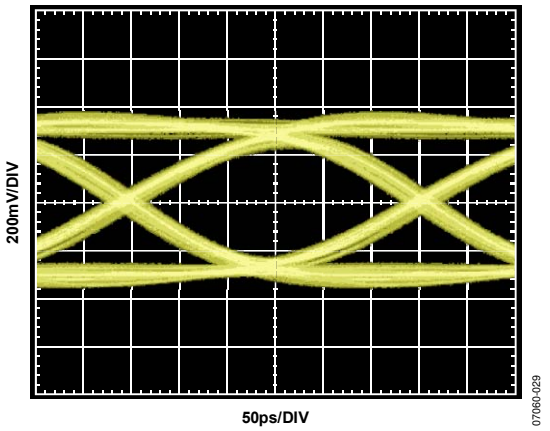

Figure 23. 3.25 Gbps Output Eye, 40 Inch FR4 Output Channel, PE = Best Setting (TP3 from Figure 20)

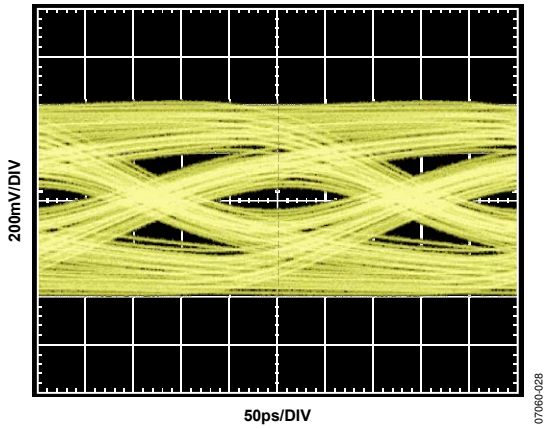

Figure 22. 3.75 Gbps Output Eye, 40 Inch FR4 Output Channel, PE = 0 (TP3 from Figure 20)

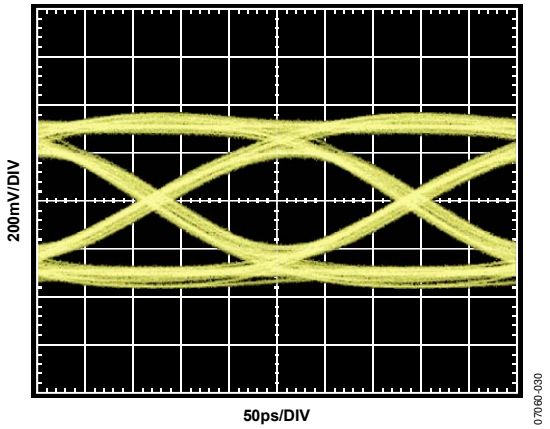

Figure 24. 3.75 Gbps Output Eye, 40 Inch FR4 Output Channel, PE = Best Setting (TP3 from Figure 20)

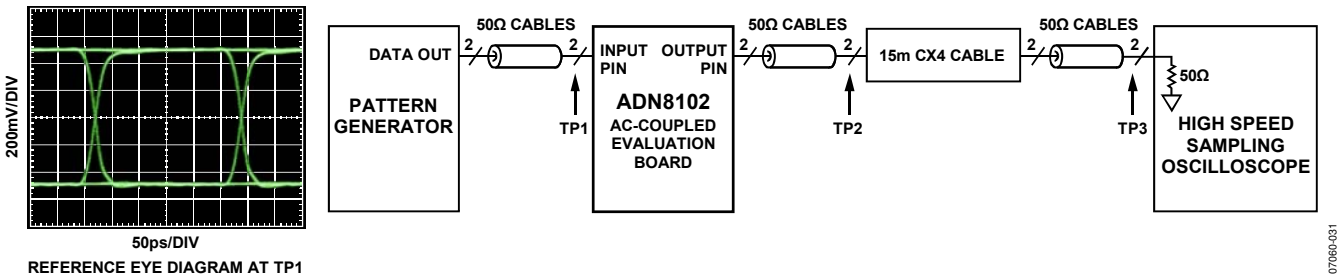

Figure 25. Output Pre-Emphasis Test Circuit, CX4

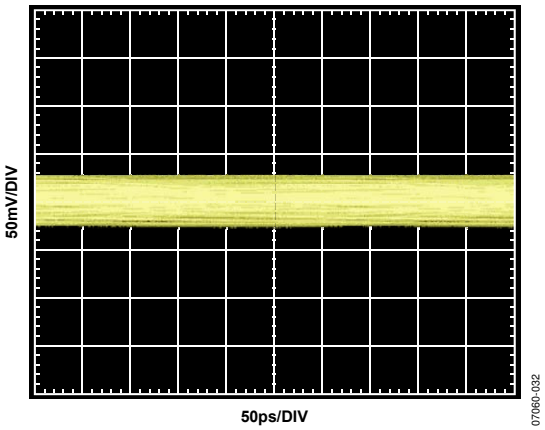

Figure 26. 3.25 Gbps Output Eye, 15 Meters CX4 Cable, PE = 0 (TP3 from Figure 25)

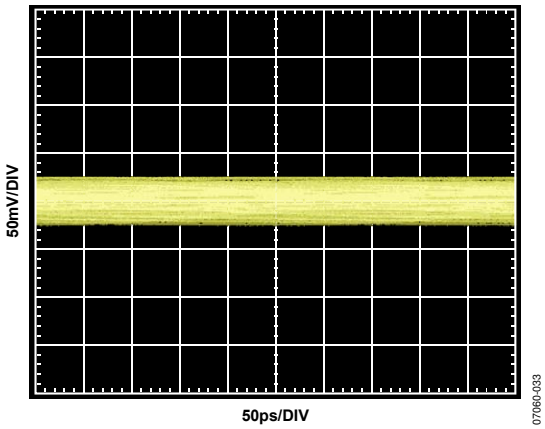

Figure 27. 3.75 Gbps Output Eye, 15 Meters CX4 Cable, PE = 0 (TP3 from Figure 25)

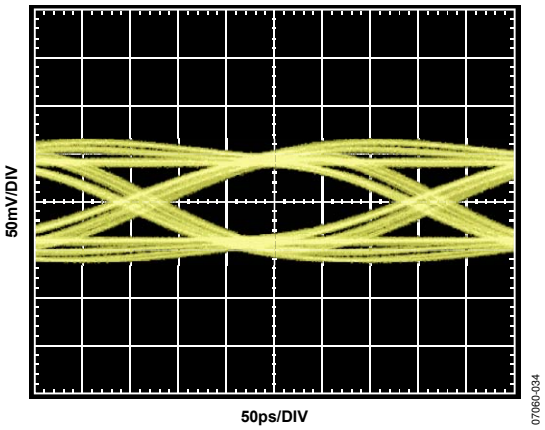

Figure 28. 3.25 Gbps Output Eye, 15 Meters CX4 Cable, PE = Best Setting (TP3 from Figure 25)

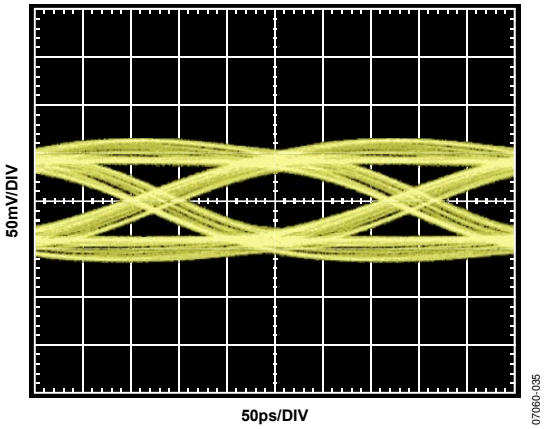

Figure 29. 3.75 Gbps Output Eye, 15 Meters CX4 Cable, PE = Best Setting (TP3 from Figure 25)

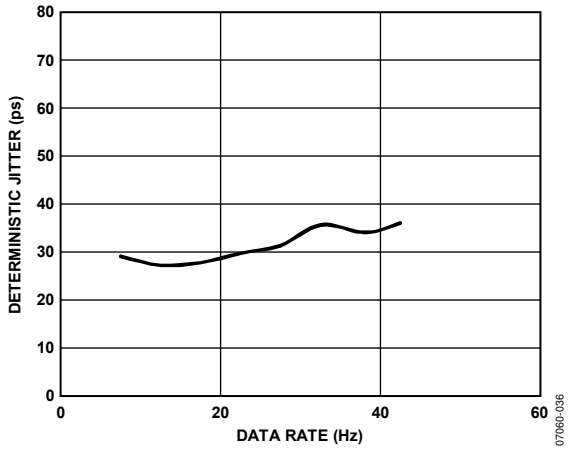

Figure 30. Deterministic Jitter vs. Data Rate

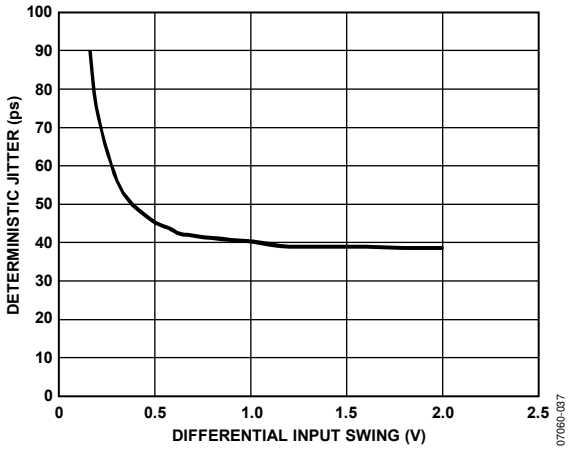

Figure 31. Deterministic Jitter vs. Differential Input Swing

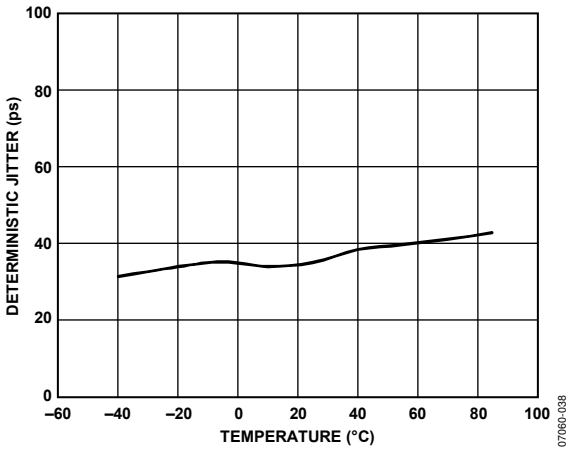

Figure 32. Deterministic Jitter vs. Temperature

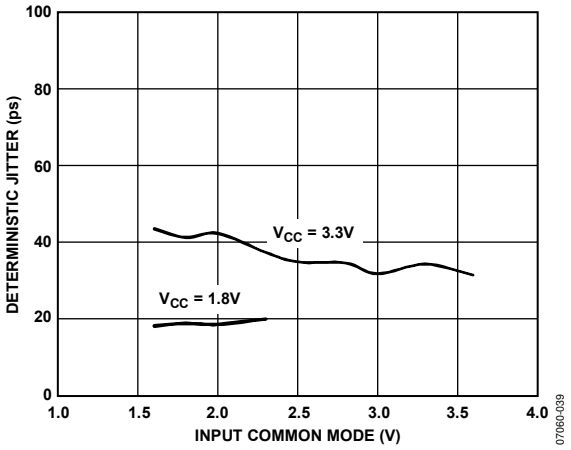

Figure 33. Deterministic Jitter vs. Input Common Mode

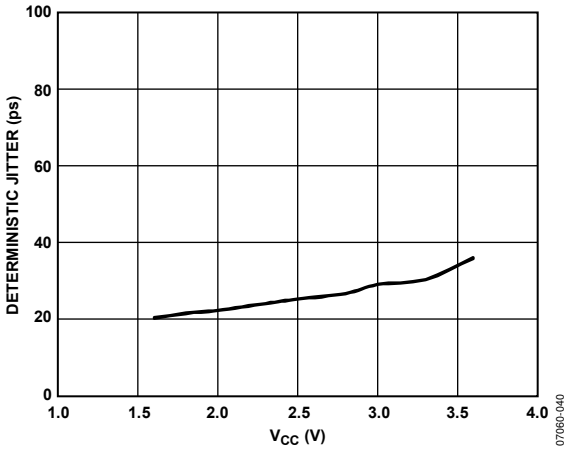

Figure 34. Deterministic Jitter vs. Supply Voltage (V_{CC})

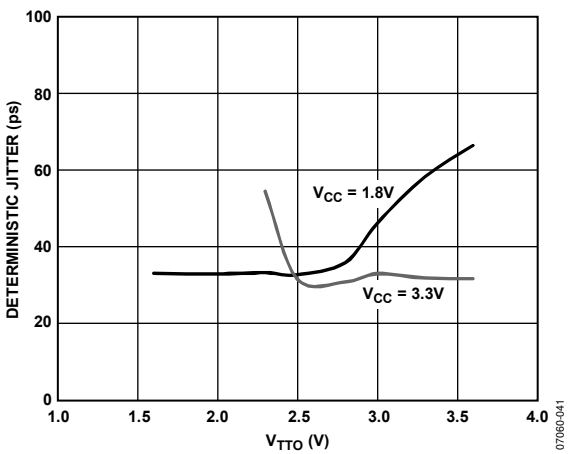

Figure 35. Deterministic Jitter vs. Output Termination Voltage (V_{TTO})

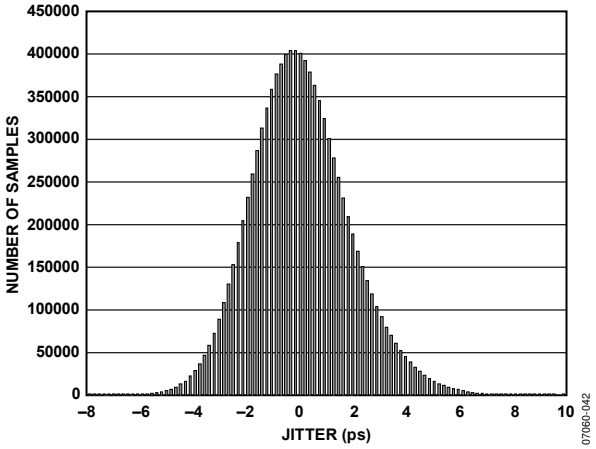

Figure 36. Random Jitter Histogram

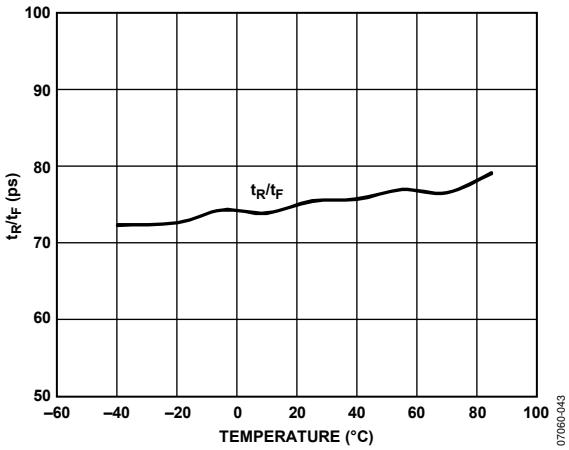

Figure 37. Rise Time (t_R)/Fall Time (t_F) vs. Temperature

THEORY OF OPERATION

INTRODUCTION

The ADN8102 is a quad, bidirectional cable and backplane equalizer that provides both input equalization and output pre-emphasis on both the line card and cable sides of the device. The device supports full loopback and through connectivity of the two unidirectional half-links, each consisting of four differential signal pairs.

The ADN8102 offers extensively programmable output levels and pre-emphasis as well as the ability to disable the output current. The receivers integrate a programmable, multizero equalizer transfer function that is optimized to compensate either typical backplane or typical cable losses.

The I/O on-chip termination resistors are terminated to user-settable supplies to support dc coupling in a wide range of logic styles. The ADN8102 supports a wide core supply range; V_{CC} can be set from 1.8 V to 3.3 V. These features, together with programmable output levels, allow for a wide range of dc- and ac-coupled I/O configurations.

The ADN8102 supports several control and configuration modes, as shown in Table 5. The pin control mode offers access to a subset of the total feature list but allows for a much simplified control scheme. The primary advantage of using the serial control interface is that it allows finer resolution in setting receive equalization, transmitter preemphasis, loss-of-signal (LOS) behavior, and output levels.

By default, the ADN8102 starts in pin control mode. Strobing the $\overline{\text{RESET}}$ pin sets all on-chip registers to their default values and uses pins to configure loopback, PE, and EQ levels. In mixed mode, loopback is still controlled through the external pin. The user can override PE and EQ settings in mixed mode. In serial mode, all functions are accessed through registers, and the control pin inputs are ignored, except $\overline{\text{RESET}}$.

The ADN8102 register set is controlled through a 2-wire, I²C interface. The ADN8102 acts only as an I²C slave device. The 7-bit slave address for the ADN8102 I²C interface contains the static value b10010 for the upper four bits. The lower two bits are controlled by the input pins, ADDR[1:0]

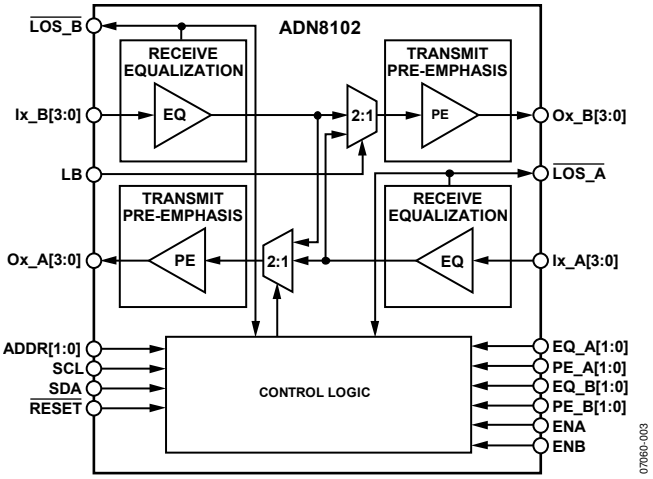

Figure 38. Simplified Functional Block Diagram

Table 5. Control Interface Mode Register

Address	Default	Register Name	Bit	Bit Name	Functionality Description
0x0F	0x00	Control	7:2	Reserved	Set to 0.
		interface mode	1:0	MODE[1:0]	00 = toggle pin control. Asynchronous control through toggle pins only.
					01 = Loopback control via toggle pins, equalization, and preemphasis via register-based control through the I²C serial interface.
					10 = Equalization and preemphasis via toggle pins and loopback control via register-based control through the I²C serial interface.
					11 = serial control. Register-based control through the I²C serial interface.

RECEIVERS

Input Structure and Input Levels

The ADN8102 receiver inputs incorporate 50 Ω termination resistors, ESD protection, and a multizero transfer function equalizer that can be optimized for backplane or cable operation. Each channel also provides a programmable LOS function that provides an interrupt that can be used to squelch or disable the associated output when the differential input voltage falls below the programmed threshold value. Each receive channel also provides a P/N inversion function that allows the user to swap the sign of the input signal path to eliminate the need for board-level crossovers in the receiver channel.

Table 6 illustrates some, but not all, possible combinations of input supply voltages.

Table 6. Common Input Voltage Levels

Configuration	V_{CC} (V)	V_{TTI} (V)
Low V_{TTI}, ac-coupled input	1.8	1.6
Single 1.8 V supply	1.8	1.8
3.3 V core	3.3	1.8
Single 3.3 V supply	3.3	3.3

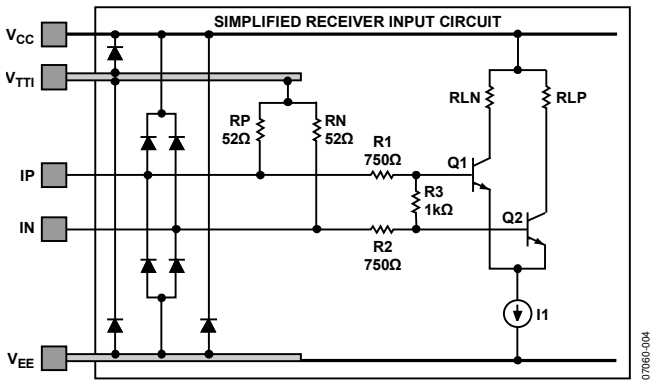

Figure 39. Simplified Input Structure

EQUALIZATION SETTINGS

The ADN8102 receiver incorporates a multizero transfer function, continuous time equalizer that provides up to 22 dB of high frequency boost at 1.875 GHz to compensate up to 30 meters of CX4 cable or 40 inches of FR4 at 3.75 Gbps. The ADN8102 allows joint control of the equalizer transfer function of the four equalizer channels in a single port through the I²C control interface. Port A and Port B equalizer transfer functions are controlled via Register 0x80 and Register 0xA0, respectively. The equalizer transfer function allows independent control of the boost in two different frequency ranges for optimal matching with the loss shape of the user's channel (for example, skin-effect loss dominated or dielectric loss dominated). By default, the equalizer control is simplified to two independent look up tables (LUT) of basic settings that provide nine settings, each optimized for CX4 cable and FR4 to ease programming for typical channels. The default state of the part selects the CX4 optimized equalization map for the IN_A[3:0] channels that interface with the cable and the FR4 optimized equalization map for the IN_B[3:0] channels that interface with the board. Full control of the equalizer is available via the I²C control interface by writing MODE[0] = 1 at Address 0x0F. Table 8 summarizes the high frequency boost for each of the basic control settings and the typical length of CX4 cable and FR4 trace that each setting compensates. Setting the EQBY bit of the IN_A/IN_B configuration registers high sets the equalization to 1.5 dB of boost, which compensates 0 meters to 2 meters of CX4 or 0 inches to 5 inches of FR4.

Setting the LUT SELECT bit = 1 (Bit 1 in the IN_Ax/IN_Bx FR4 control registers) allows the default map selection (CX4 or FR4 optimized) to be overwritten via the LUT FR4/CX4 bit (Bit 0) in the IN_Ax/IN_Bx FR4 control registers. Setting this bit high selects the FR4 optimized map, and setting it low selects the CX4 optimized map. These settings are set on a per channel basis (see Table 9 and Table 22).

Table 7.

LUT SELECT	LUT FR4/CX4	Description
0 (default)	X[1]	Port A eq optimized for CX4 cable Port B eq optimized for FR4 PCB trace
1	0	Eq optimized for CX4 cable
1	1	Eq optimized for FR4 PCB trace

[1] X = don't care.

Advanced Equalization Settings

The user can also specify the boost in the midfrequency and high frequency ranges independently. This is done by writing to the IN_A/IN_B EQ1 control and IN_A/IN_B EQ2 control registers for the channel of interest. Each of these registers provides 32 settings of boost, with IN_A/IN_B EQ1 control setting the midfrequency boost and IN_A/IN_B EQ2 control setting the high frequency boost. The IN_A/IN_B EQx control registers are ordered such that Bit 5 is a sign bit, and midlevel boost is centered on 0x00; setting Bit 5 low and increasing the LSBs results in decreasing boost, while setting Bit 5 high and increasing the LSBs results in increasing boost. The EQ CTL SRC bit (Bit 6) in the IN_A/IN_B EQ1 control registers determines whether the equalization control for the channel of interest is selected from the optimized map or directly from the IN_A/IN_B EQx control registers (per port). Setting this bit high selects equalization control directly from the IN_A/IN_B EQx control registers, and setting it low selects equalization control from the selected optimized map.

Table 8. Receive Equalizer Boost vs. Setting (CX4 and FR4 Optimized Maps)

EQ_A[1:0] and EQ_B[1:0] Pins	IN_Ax/IN_Bx Configuration, EQ[2:0]	EQBY	Cable Optimized		FR4 Optimized	
			Boost (dB)	Typical CX4 Cable Length (Meters)	Boost (dB)	Typical FR4 Trace Length (Inches)
	X[1]	1	1.5	< 2	1.5	< 5
0	0	0	10	2 to 6	3.5	5 to 10
	1	0	12	8 to 10	3.9	10 to 15
1	2	0	14	12 to 14	4.25	15 to 20
	3	0	17	16 to 18	4.5	20 to 25
	4	0	19	20 to 22	4.75	25 to 30
2	5	0	20	24 to 26	5.0	30 to 35
	6	0	21	28 to 30	5.3	35 to 40
3	7	0	22	30 to 32	5.5	35 to 40

[1] X = Don't care

Table 9. Receive Configuration and Equalization Registers

Name	Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default
IN_A/IN_B configuration	0x80, 0xA0		PNSWAP	EQBY	EN		EQ[2]	EQ[1]	EQ[0]	0x30
IN_A/IN_B EQ1 control	0x83, 0xA3		EQ CTL SRC	EQ1[5]	EQ1[4]	EQ1[3]	EQ1[2]	EQ1[1]	EQ1[0]	0x00
IN_A/IN_B EQ2 control	0x84, 0xA4			EQ2[5]	EQ2[4]	EQ2[3]	EQ2[2]	EQ2[1]	EQ2[0]	0x00
IN_Ax/IN_Bx FR4 control	0x85, 0x8D, 0x95, 0x9D, 0xA5, 0xAD, 0xB5, 0xBD							LUT SELECT	LUT FR4/CX4	0x00

Loss of Signal/Signal Detect

An independent signal detect output is provided for all eight input ports of the device. The signal-detect function measures the low frequency amplitude of the signal at the receiver input and compares this measurement with a defined threshold level. If the measurement indicates that the input signal swing is smaller than the threshold for 250 µs, the channel indicates a loss-of-signal event. Assertion and deassertion of the LOS signal occurs within 100 µs of the event.

The LOS-assert and LOS-deassert levels are set on a per channel basis through the I²C control interface, by writing to the IN_A/IN_B LOS threshold and IN_A/IN_B LOS hysteresis registers, respectively. The recommended settings are IN_A/IN_B LOS threshold = 0x0C and IN_A/IN_B LOS hysteresis = 0x0D. All ports are factory tested with these settings to ensure that an LOS event is asserted for single-ended dc input swings less than 20 mV and is deasserted for single-ended dc input swings greater than 225 mV.

The LOS status for each individual channel can be accessed through the I²C control interface. The independent channel LOS status can be read from the IN_A/IN_B LOS status registers (Address 0x1F and Address 0x3F). The four LSBs of each register represent the current LOS status of each channel, with high representing an ongoing LOS event. The four MSBs of each register represent the historical LOS status of each channel, with high representing a LOS event at any time on a specific channel. The MSBs are sticky and remain high once asserted until cleared by the user by overwriting the bits to 0.

Recommended LOS Settings

Recommended settings for LOS are as follows:

- Set IN_A/IN_B LOS threshold to 0x0C for an assert voltage of 20 mV differential (40 mV p-p differential).
- Set IN_A/IN_B LOS hysteresis to 0x0D for a deassert voltage of 225 mV differential (450 mV p-p differential).

LANE INVERSION

The input P/N inversion is a feature intended to allow the user to implement the equivalent of a board-level crossover in a much smaller area and without additional via impedance discontinuities that degrade the high frequency integrity of the signal path. The P/N inversion is available on a per port basis and is controlled through the I²C control interface. The P/N inversion is accomplished by writing to the PNSWAP bit (Bit 6) of the IN_A/IN_B configuration register (see Table 9) with low representing a noninverting configuration and high representing an inverting configuration. Note that using this feature to account for signal inversions downstream of the receiver requires additional attention when switching connectivity.

Table 10. LOS Threshold and Hysteresis Control Registers

Name	Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default
IN_A/IN_B LOS threshold	0x81, 0xA1		THRESH[6]	THRESH[5]	THRESH[4]	THRESH[3]	THRESH[2]	THRESH[1]	THRESH[0]	0x04
IN_A/IN_B LOS hysteresis	0x82, 0xA2		HYST[6]	HYST[5]	HYST[4]	HYST[3]	HYST[2]	HYST[1]	HYST[0]	0x12

Table 11. LOS Status Registers

Name	Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
IN_A/IN_B LOS status	0x1F, 0x3F	STICKY LOS[3]	STICKY LOS[2]	STICKY LOS[1]	STICKY LOS[0]	REAL-TIME LOS[3]	REAL-TIME LOS[2]	REAL-TIME LOS[1]	REAL-TIME LOS[0]

LOOPBACK

The ADN8102 provides loopback on both input ports (Port A: cable interface input, and Port B: line card interface input). The external loopback toggle pin, LB, controls the loopback of the Port B input only (board side loopback). When loopback is asserted, valid data continues to pass through the Port B link, but the Port B input signals are also shunted to the Port A output to allow testing and debugging without disrupting valid data. This loopback, as well as loopback of the Port A input (cable side loopback), can be programmed through the I²C interface. The loopbacks are controlled through the I²C interface by writing to Bit 0 and Bit 1 of the loopback control register (Register 0x02).

Bit 0 represents loopback of the Port A inputs to the Port B outputs (cable side loopback). Bit 1 represents loopback of the Port B inputs to the Port A outputs (board side loopback), with high representing loopback for both bits. Bit 1 can be overridden by the LB pin if the pin mode register is set to enable loopback via external pin as shown in Table 5. Both input ports can be looped back simultaneously (full loopback) by writing high to both Bit 0 and Bit 1, but in this case, valid data is disrupted on each channel. Figure 40 illustrates the three loopback modes.

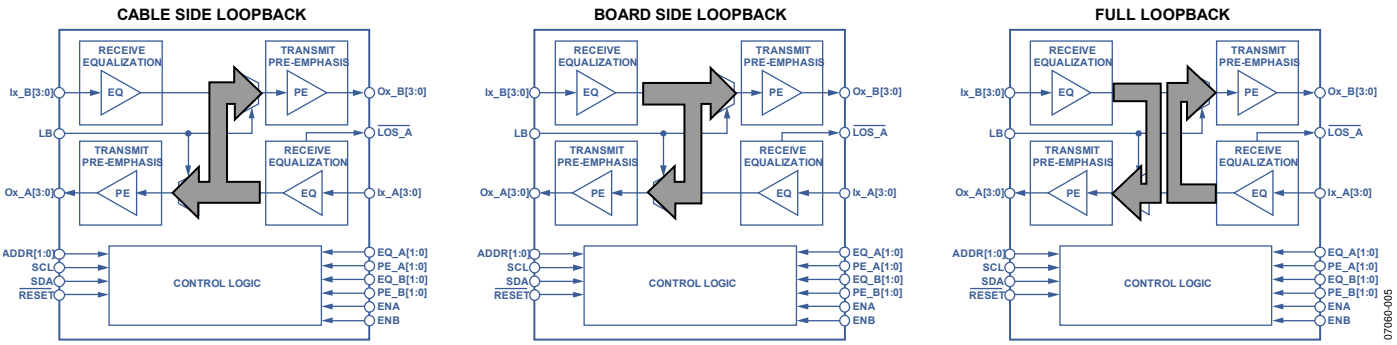

Figure 40. Loopback Modes of Operation

Table 12. Loopback Control Functionality

Control Mode[1]	LB Pin	LB[1]	LB[0]	Description
Pin Control (00 or 01)	0	X[2]	X	Loopback disabled
	1	X	X	Board side loopback enabled
Serial Control	X	0	0	Loopback disabled
(10 or 11)	X	0	1	Cable side loopback enabled
	X	1	0	Board side loopback enabled
	X	1	1	Full loopback enabled

[1] Refer to Table 5 for additional information regarding control mode settings.
[2] X = don't care.

Table 13. Loopback Control Register

Name	Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default
Loopback control	0x02							LB[1]	LB[0]	0x00

TRANSMITTERS

Output Structure and Output Levels

The ADN8102 transmitter outputs incorporate 50 Ω termination resistors, ESD protection, and an output current switch. Each port provides control of both the absolute output level and the pre-emphasis output level. It should be noted that the choice of output level affects the output common-mode level. A 600 mV peak-to-peak differential output level with full pre-emphasis range requires an output termination voltage of 2.5 V or greater (V_{TTO}, $V_{CC} \geq 2.5$ V).

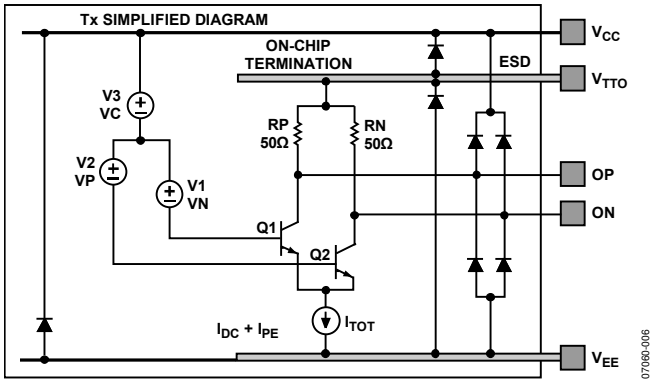

Figure 41. Simplified Output Structure

Pre-Emphasis

The total output amplitude and pre-emphasis setting space is reduced to a single map of basic settings that provide seven settings of output equalization to ease programming for typical channels. The PE_A/PE_B[1:0] pins provide selections 0, 2, 4, and 6 of the seven pre-emphasis settings through toggle pin control, covering the entire range of settings at lower resolution. The full resolution of seven settings is available through the I²C interface by writing to Bits[2:0] (PE[2:0] of the OUT_A/OUT_B configuration registers) with I²C settings overriding the toggle pin control. Similar to the receiver settings, the ADN8102 allows joint control of all four channels in a transmit port. Table 15 summarizes the absolute output level, pre-emphasis level, and high frequency boost for each of the basic control settings and the typical length of the CX4 cable and FR4 trace that each setting compensates.

Full control of the transmit output levels is available through the I²C control interface. This full control is achieved by writing to the OUT_A/OUT_B Output Level Control[1:0] registers for the channel of interest. Table 17 shows the supported output level settings of the OUT_A/OUT_B Output Level Control[1:0] registers. Register settings not listed in Table 17 are not supported by the ADN8102.

The output equalization is optimized for less than 1.75 Gbps operation but can be optimized for higher speed applications at up to 3.75 Gbps through the I²C control interface by writing to the DATA RATE bit (Bit 4) of the OUT_A/OUT_B configuration registers, with high representing 3.75 Gbps and low representing 1.75 Gbps. The PE CTL SRC bit (Bit 7) in the OUT_A/OUT_B Output Level Control 1 register determines whether the pre-emphasis and output current controls for the channel of interest are selected from the optimized map or directly from the OUT_A/OUT_B Output Level Control[1:0] registers (per channel). Setting this bit high selects pre-emphasis control directly from the OUT_A/OUT_B Output Level Control[1:0] registers, and setting it low selects pre-emphasis control from the optimized map.

Table 14. Data Rate Select

OUT_A/OUT_B Configuration Bit 4	Supported Data Rates
0 (default)	0 Gbps to 1.75 Gbps
1	1.75 Gbps to 3.75 Gbps

Table 15. Transmit Pre-Emphasis Boost and Overshoot vs. Setting

PE[2:0] Register	PE[1:0] Pins	Boost (dB)	Overshoot (%)	DC Swing (mV p-p diff)	Typical CX4 Cable Length (Meters)	Typical FR4 Trace Length (Inches)
0	0	0	0	800	0 to 2.5	0 to 5
1	Not applicable	2	25	800	2.5 to 5	0 to 5
2	1	3.5	50	800	5 to 7.5	10 to 15
3	Not applicable	4.9	75	800	7.5 to 10	10 to 15
4	2	6	100	800	10 to 12.5	15 to 20
5	Not applicable	7.4	133	600	15 to 17.5	20 to 25
6	4	9.5	200	400	20 to 22.5	25 to 30

Table 16. Output Configuration Registers

Name	Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default
OUT_A/OUT_B configuration	0xC0, 0xE0			EN	DATA RATE		PE[2]	PE[1]	PE[0]	0x20
OUT_A/OUT_B Output Level Control 1	0xC1, 0xE1	PE CTL SRC	OUTx_OLEV1[6:0]							0x40
OUT_A/OUT_B Output Level Control 0	0xC2, 0xE2		OUTx_OLEV0[6:0]							0x40

Table 17. Output Level Settings

V_{SW-DC} (mV)	V_{SW-PE} (mV)	V_{DPP-DC} (mV)	V_{DPP-PE} (mV)	PE (dB)	I_{TOT} (mA)	OUT_A/OUT_B OLEV 0	OUT_A/OUT_B OLEV 1
50	50	100	100	0.00	2	0x00	0x81
50	150	100	300	9.54	6	0x11	0x81
50	250	100	500	13.98	10	0x22	0x81
50	350	100	700	16.90	14	0x33	0x81
50	450	100	900	19.08	18	0x44	0x81
50	550	100	1100	20.83	22	0x55	0x81
50	650	100	1300	22.28	26	0x66	0x81
100	100	200	200	0.00	4	0x00	0x91
100	200	200	400	6.02	8	0x11	0x91
100	300	200	600	9.54	12	0x22	0x91
100	400	200	800	12.04	16	0x33	0x91
100	500	200	1000	13.98	20	0x44	0x91
100	600	200	1200	15.56	24	0x55	0x91
100	700	200	1400	16.90	28	0x66	0x91
150	150	300	300	0.00	6	0x00	0x92
150	250	300	500	4.44	10	0x11	0x92
150	350	300	700	7.36	14	0x22	0x92
150	450	300	900	9.54	18	0x33	0x92
150	550	300	1100	11.29	22	0x44	0x92
150	650	300	1300	12.74	26	0x55	0x92
150	750	300	1500	13.98	30	0x66	0x92
200	200	400	400	0.00	8	0x00	0xA2
200	300	400	600	3.52	12	0x11	0xA2
200	400	400	800	6.02	16	0x22	0xA2
200	500	400	1000	7.96	20	0x33	0xA2
200	600	400	1200	9.54	24	0x44	0xA2
200	700	400	1400	10.88	28	0x55	0xA2
200	800	400	1600	12.04	32	0x66	0xA2
250	250	500	500	0.00	10	0x00	0xA3
250	350	500	700	2.92	14	0x11	0xA3
250	450	500	900	5.11	18	0x22	0xA3
250	550	500	1100	6.85	22	0x33	0xA3
250	650	500	1300	8.30	26	0x44	0xA3
250	750	500	1500	9.54	30	0x55	0xA3
250	850	500	1700	10.63	34	0x66	0xA3
300	300	600	600	0.00	12	0x00	0xB3
300	400	600	800	2.50	16	0x11	0xB3
300	500	600	1000	4.44	20	0x22	0xB3
300	600	600	1200	6.02	24	0x33	0xB3
300	700	600	1400	7.36	28	0x44	0xB3
300	800	600	1600	8.52	32	0x55	0xB3
300	900	600	1800	9.54	36	0x66	0xB3
350	350	700	700	0.00	14	0x00	0xB4
350	450	700	900	2.18	18	0x11	0xB4
350	550	700	1100	3.93	22	0x22	0xB4
350	650	700	1300	5.38	26	0x33	0xB4
350	750	700	1400	6.62	30	0x44	0xB4
350	850	700	1700	7.71	34	0x55	0xB4
350	950	700	1900	8.67	38	0x66	0xB4
400	400	800	800	0.00	16	0x00	0xC4
400	500	800	1000	1.94	20	0x11	0xC4
400	600	800	1200	3.52	24	0x22	0xC4
400	700	800	1400	4.86	28	0x33	0xC4
400	800	800	1600	6.02	32	0x44	0xC4
400	900	800	1800	7.04	36	0x55	0xC4
400	1000	800	2000	7.96	40	0x66	0xC4

V_{SW-DC} (mV)	V_{SW-PE} (mV)	V_{DPP-DC} (mV)	V_{DPP-PE} (mV)	PE (dB)	I_{TOT} (mA)	OUT_A/OUT_B OLEV 0	OUT_A/OUT_B OLEV 1
450	450	900	900	0.00	18	0x00	0xC5
450	550	900	1100	1.74	22	0x11	0xC5
450	650	900	1300	3.19	26	0x22	0xC5
450	750	900	1500	4.44	30	0x33	0xC5
450	850	900	1700	5.52	34	0x44	0xC5
450	950	900	1900	6.49	38	0x55	0xC5
450	1050	900	2100	7.36	42	0x66	0xC5
500	500	1000	1000	0.00	20	0x00	0xD5
500	600	1000	1200	1.58	24	0x11	0xD5
500	700	1000	1400	2.92	28	0x22	0xD5
500	800	1000	1600	4.08	32	0x33	0xD5
500	900	1000	1800	5.11	36	0x44	0xD5
500	1000	1000	2000	6.02	40	0x55	0xD5
500	1100	1000	2200	6.85	44	0x66	0xD5
550	550	1100	1100	0.00	22	0x00	0xD6
550	650	1100	1300	1.45	26	0x11	0xD6
550	750	1100	1500	2.69	30	0x22	0xD6
550	850	1100	1700	3.78	34	0x33	0xD6
550	950	1100	1900	4.75	38	0x44	0xD6
550	1050	1100	2100	5.62	42	0x55	0xD6
550	1150	1100	2300	6.41	46	0x66	0xD6
600	600	1200	1200	0.00	24	0x00	0xE6
600	700	1200	1400	1.34	28	0x11	0xE6
600	800	1200	1600	2.50	32	0x22	0xE6
600	900	1200	1800	3.52	36	0x33	0xE6
600	1000	1200	2000	4.44	40	0x44	0xE6
600	1100	1200	2200	5.26	44	0x55	0xE6
600	1200	1200	2400	6.02	48	0x66	0xE6
650	650	1300	1300	0.00	26	0x01	0xE6
650	750	1300	1500	1.24	30	0x12	0xE6
650	850	1300	1700	2.33	34	0x23	0xE6
650	950	1300	1900	3.30	38	0x34	0xE6
650	1050	1300	2100	4.17	42	0x45	0xE6
650	1150	1300	2300	4.96	46	0x56	0xE6
700	700	1400	1400	0.00	28	0x02	0xE6
700	800	1400	1600	1.16	32	0x13	0xE6
700	900	1400	1800	2.18	36	0x24	0xE6
700	1000	1400	2000	3.10	40	0x35	0xE6
700	1100	1400	2300	3.93	44	0x46	0xE6
750	750	1500	1500	0.00	30	0x03	0xE6
750	850	1500	1700	1.09	34	0x14	0xE6
750	950	1500	1900	2.05	38	0x25	0xE6
750	1050	1500	2100	2.92	42	0x36	0xE6
800	800	1600	1600	0.00	32	0x04	0xE6
800	900	1600	1800	1.02	36	0x15	0xE6
800	1000	1600	2000	1.94	40	0x26	0xE6
850	850	1700	1700	0.00	34	0x05	0xE6
850	950	1700	1900	0.97	38	0x16	0xE6
900	900	1800	1800	0.00	36	0x06	0xE6

SELECTIVE SQUELCH AND DISABLE

Each transmitter is equipped with output disable and output squelch controls. Disable is a full power-down state: the transmitter current is reduced to zero, and the output pins pull up to V_{TTO}, but there is a delay of approximately 1 µs associated with re-enabling the transmitter. The output disable control is accessed through the EN bit (Bit 4) of the OUT_A/OUT_B configuration registers through the I^2C control interface.

Squelch is not a full power-down state but a state in which only the output current is reduced to zero and the output pins pull up to V_{TTO}, and there is a much smaller delay to bring back the output current. The output squelch and the output disable control can both be accessed through the OUT_A/OUT_B squelch control registers, with the top nibble representing the squelch control for one entire output port, and the bottom nibble representing the output disable for one entire output port. The ports are disabled or squelched by writing 0s to the corresponding nibbles. The ports are enabled by writing all 1s, which is the default setting. For example, to squelch Port A, Register 0xC3 must be set to 0x0F. The entire nibble must be written to all 0s for this functionality.

Table 18. Squelch and Disable Control Registers

Name	Address	Data		Default
OUT_A/ OUT_B squelch control	0xC3, 0xE3	$\overline{\text{SQUELCH[3:0]}}$	$\overline{\text{DISABLE[3:0]}}$	0xFF

Table 19. Squelch and Disable Functionality

$\overline{\text{SQUELCH[3:0]}}$	$\overline{\text{DISABLE[3:0]}}$	Output State
1111	1111	Enabled (default)
xxxx[1]	0000	Disabled
0000	1111	Squelched

[1] xxxx = don't care